

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2624914

| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | | | |
|--|--------------------------------|---------------|-------------------------------|---------------------|--------------------------------|-------------------|----------------|-------|--------|----------------|-------|--------------|-------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>CHEE SENG FOONG</td> <td>11/18/2013</td> </tr> <tr> <td>LAN CHU TAN</td> <td>11/01/2013</td> </tr> </tbody> </table> | | Name | Execution Date | CHEE SENG FOONG | 11/18/2013 | LAN CHU TAN | 11/01/2013 | | | | | | |
| Name | Execution Date | | | | | | | | | | | | |
| CHEE SENG FOONG | 11/18/2013 | | | | | | | | | | | | |
| LAN CHU TAN | 11/01/2013 | | | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | | | |
| <table border="1"> <tr> <td>Name:</td> <td>Freescall Semiconductor, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>6501 William Cannon Drive West</td> </tr> <tr> <td>Internal Address:</td> <td>Law Department</td> </tr> <tr> <td>City:</td> <td>Austin</td> </tr> <tr> <td>State/Country:</td> <td>TEXAS</td> </tr> <tr> <td>Postal Code:</td> <td>78735</td> </tr> </table> | | Name: | Freescall Semiconductor, Inc. | Street Address: | 6501 William Cannon Drive West | Internal Address: | Law Department | City: | Austin | State/Country: | TEXAS | Postal Code: | 78735 |
| Name: | Freescall Semiconductor, Inc. | | | | | | | | | | | | |
| Street Address: | 6501 William Cannon Drive West | | | | | | | | | | | | |
| Internal Address: | Law Department | | | | | | | | | | | | |
| City: | Austin | | | | | | | | | | | | |
| State/Country: | TEXAS | | | | | | | | | | | | |
| Postal Code: | 78735 | | | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14086932</td> </tr> </tbody> </table> | | Property Type | Number | Application Number: | 14086932 | | | | | | | | |
| Property Type | Number | | | | | | | | | | | | |
| Application Number: | 14086932 | | | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | | | |
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| Email: | USADOCKETING@freescall.com | | | | | | | | | | | | |
| <i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i> | | | | | | | | | | | | | |
| Correspondent Name: | DEE MATOCHA | | | | | | | | | | | | |
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| Address Line 2: | TX30/OE62 | | | | | | | | | | | | |
| Address Line 4: | AUSTIN, TEXAS 78735 | | | | | | | | | | | | |
| ATTORNEY DOCKET NUMBER: | MT12556AK | | | | | | | | | | | | |
| NAME OF SUBMITTER: | CASSIE YE | | | | | | | | | | | | |
| Signature: | /Cassie Ye/ | | | | | | | | | | | | |

Date:

11/21/2013

Total Attachments: 3

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PATENT

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **CHEE SENG FOONG AND LAN CHU TAN, BOTH OF MALAYSIA** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto FREESCALE SEMICONDUCTOR, INC., a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **PILLAR BUMP FORMED USING SPOT-LASER** (Docket No. **MT12556AK**), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent which may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

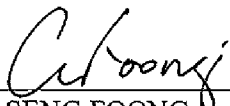
We hereby also sell, assign and transfer unto FREESCALE SEMICONDUCTOR, INC., the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and we further authorize FREESCALE SEMICONDUCTOR, INC. to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

We hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to FREESCALE SEMICONDUCTOR, INC., for the sole use and benefit of FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and we hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to FREESCALE SEMICONDUCTOR, INC.

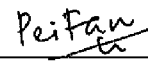
We agree that, when requested, we will, without charge to FREESCALE SEMICONDUCTOR, INC., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives or nominees.

MT12556AK

We covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

 DATE: NOV 18 2013
CHEE SENG FOONG


First Witness

 DATE: NOV 18 2013
SIGNATURE OF WITNESS (Month-Day-Year)

TONG PEI FAN
PRINTED NAME OF WITNESS

26, JALAN IMPIAN INDAH 3, TAMAN IMPIAN INDAH,
PRINTED ADDRESS OF WITNESS BUKIT JALIL, 5700 KL

Second Witness

 DATE: NOV 18 2013
SIGNATURE OF WITNESS (Month-Day-Year)

TOOK SHENG PING
PRINTED NAME OF WITNESS

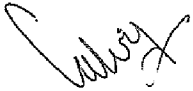
36, JALAN PUTRA SETIA 6/1L, PUTRA HEIGHTS, 47650
PRINTED ADDRESS OF WITNESS SUBANG JAYA



LAN CHU TAN

DATE: NOV 01 2013

First Witness



SIGNATURE OF WITNESS

DATE: NOV 01 2013
(Month-Day-Year)

LO WAI YEW
PRINTED NAME OF WITNESS

NO. 08-02, JLN PJU 3/34, MALAYSIA
PRINTED ADDRESS OF WITNESS

Second Witness



SIGNATURE OF WITNESS

DATE: November - 01 - 2013
(Month-Day-Year)

STANLEY JOB DRAISAMY
PRINTED NAME OF WITNESS

NO. 32, JALAN 54/28, TAMAN SERI RAMPAI, SETAPAN, 53300 K. L.
PRINTED ADDRESS OF WITNESS